

# NCP585

## Tri-Mode 300 mA CMOS LDO Regulator with Enable

The NCP585 series of low dropout regulators are designed for portable battery powered applications which require precise output voltage accuracy, low quiescent current, and high ripple rejection. These devices feature an enable function which lowers current consumption significantly and are offered in the SOT23-5 and the HSON-6 packages.

This series of devices have three modes. Chip Enable (CE mode), Fast Transient Mode (FT mode), and Low Power Mode (LP mode). Both the FT and LP mode are utilized via the ECO pin.

### Features

- Tri-mode Operation
- Low Dropout Voltage:
  - Typ 550 mV at 300 mA, Output Voltage = 0.9 V
  - Typ 480 mV at 300 mA, Output Voltage = 1.0 V
  - Typ 310 mV at 300 mA, Output Voltage = 1.5 V
- Excellent Line Regulation of 0.01%/V (0.05%/V LP Mode)
- Excellent Load Regulation of 15 mV (40 mV FT Mode)
- High Output Voltage Accuracy of  $\pm 2\%$  ( $\pm 3\%$  LP mode)
- Ultra-Low I<sub>q</sub> Current of:
  - 3.5  $\mu$ A (LP mode, Output Voltage < 1.6 V)
  - 80  $\mu$ A (FT mode, Output Voltage < 1.8 V)
  - 60  $\mu$ A (FT mode, Output Voltage = 1.8 V)
- Very Low Shutdown Current of 0.1  $\mu$ A
- Excellent Power Supply Rejection Ratio of 70 dB at f = 1.0 kHz
- Output Voltage Options: 0.9, 1.2 and 1.8 V
- Low Temperature Drift Coefficient on the Output Voltage of  $\pm 100$  ppm/ $^{\circ}$ C
- Fold Back Protection Circuit
- Input Voltage up to 6.5 V
- These are Pb-Free Devices

### Typical Applications

- Portable Equipment
- Hand-Held Instrumentation
- Camcorders and Cameras

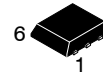
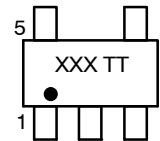


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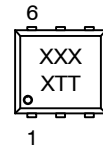
### MARKING DIAGRAMS



SOT23-5  
SN SUFFIX  
CASE 1212



HSON-6  
SAN SUFFIX  
CASE 506AE



X = Device Code  
T = Traceability Information

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 11 of this data sheet.

# NCP585

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage	$V_{in}$	6.5	V
Input Voltage ( $\overline{CE}$ or CE Pin)	$V_{CE}$	-0.3 to 6.5	V
Input Voltage (ECO Pin)	$V_{ECO}$	-0.3 to 6.5	V
Output Voltage	$V_{out}$	-0.3 to $V_{in} + 0.3$	V
Output Current	$I_{out}$	350	mA
Power Dissipation	$P_D$	250 400	mW
		SOT23-5 HSO8-6	
ESD Capability, Human Body Model, C = 100 pF, R = 1.5 k $\Omega$	$ESD_{HBM}$	2000	V
ESD Capability, Machine Model, C = 200 pF, R = 0 $\Omega$	$ESD_{MM}$	150	V
Operating Ambient Temperature Range	$T_A$	-40 to +85	$^{\circ}C$
Maximum Junction Temperature	$T_{J(max)}$	125	$^{\circ}C$
Storage Temperature Range	$T_{stg}$	-55 to +150	$^{\circ}C$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## ELECTRICAL CHARACTERISTICS ( $V_{in} = V_{out} + 1.0$ V, $T_A = 25^{\circ}C$ , unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit		
Input Voltage	$V_{in}$	1.4	-	6.0	V		
Output Voltage ( $1.0 \mu A \leq I_{out} \leq 30$ mA) $V_{ECO} = V_{in}$ $V_{ECO} = GND$	$V_{out}$	$V_{out} \times 0.980$ $V_{out} \times 0.970$	- -	$V_{out} \times 1.020$ $V_{out} \times 1.030$	V		
Line Regulation ( $I_{out} = 30$ mA, $V_{out} + 0.5$ V $\leq V_{in} \leq 6.0$ V) FT Mode $V_{ECO} = V_{in}$ LP Mode $V_{ECO} = GND$	$Reg_{line}$	- -	0.01 0.05	0.15 0.20	%/V		
Load Regulation FT Mode ( $1.0$ mA $\leq I_{out} \leq 300$ mA), $V_{ECO} = V_{in}$ LP Mode ( $1.0$ mA $\leq I_{out} \leq 100$ mA), $V_{ECO} = GND$	$Reg_{load}$	- -	40 15	70 30	mV		
Dropout Voltage ( $I_{out} = 300$ mA) $V_{out} = 0.9$ V $1.0$ V $\leq V_{out} \leq 1.25$ V $1.5$ V $\leq V_{out} \leq 2.5$ V $2.8$ V $\leq V_{out} \leq 3.3$ V	$V_{DO}$	- - - -	ECO = H 0.55 0.48 0.31 0.23	ECO = L 0.59 0.51 0.32 0.24	ECO = H 0.78 0.70 0.45 0.35	ECO = L 0.80 0.75 0.48 0.375	V
Quiescent Current ( $I_{out} = 0$ mA) FT Mode, $V_{ECO} = V_{in}$ $V_{out} < 1.8$ V $V_{out} \geq 1.8$ V LP Mode, $V_{ECO} = GND$ $V_{out} < 1.6$ V $V_{out} \geq 1.8$ V	$I_q$	- - - -	80 60 3.5 4.5	111 90 8.0 9.0	$\mu A$		
Output Current ( $V_{in} - V_{out} = 1.0$ V)	$I_{out}$	300	-	-	mA		
Shutdown Current ( $V_{CE} = V_{in}$ )	$I_{SD}$	-	0.1	1.0	$\mu A$		
Output Short Circuit Current ( $V_{out} = 0$ V)	$I_{lim}$	-	50	-	mA		
Enable Input Threshold Voltage - High - Low	$V_{th_{enh}}$ $V_{th_{enl}}$	1.0 0.0	- -	$V_{in}$ 0.3	V		
Output Noise Voltage (10 Hz - 100 kHz)	$V_n$	-	30	-	$\mu V_{rms}$		
N-Channel On Resistance for Auto Discharge	$R_{Low}$	-	60	-	$\Omega$		
Ripple Rejection ( $I_{out} = 50$ mA, $V_{out} = 0.9$ V, $V_{in} - V_{out} = 1.0$ V) $f = 120$ Hz $f = 1.0$ kHz $f = 10$ kHz	RR	- - -	75 70 65	- - -	dB		
Output Voltage Temperature Coefficient ( $I_{out} = 30$ mA, $-40^{\circ}C \leq T_A \leq 85^{\circ}C$ )	$\Delta V_{out}/\Delta T$	-	$\pm 100$	-	ppm/ $^{\circ}C$		

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## ORDERING INFORMATION

Device	Output Type / Features	Nominal Output Voltage	Marking	Package	Shipping <sup>†</sup>
NCP585DSAN09T1G	Active High w/Auto Discharge, LP and FT Mode	0.9	B09D	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585DSAN12T1G	Active High w/Auto Discharge, LP and FT Mode	1.2	B12D	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585DSAN18T1G	Active High w/Auto Discharge, LP and FT Mode	1.8	B18D	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585DSN09T1G	Active High w/Auto Discharge, LP and FT Mode	0.9	R09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN12T1G	Active High w/Auto Discharge, LP and FT Mode	1.2	R12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN125T1G	Active High w/Auto Discharge, LP and FT Mode	1.25	R01	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN15T1G	Active High w/Auto Discharge, LP and FT Mode	1.5	R15	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN18T1G	Active High w/Auto Discharge, LP and FT Mode	1.8	R18	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN25T1G	Active High w/Auto Discharge, LP and FT Mode	2.5	R25	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN28T1G	Active High w/Auto Discharge, LP and FT Mode	2.8	R28	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN30T1G	Active High w/Auto Discharge, LP and FT Mode	3.0	R30	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585DSN33T1G	Active High w/Auto Discharge, LP and FT Mode	3.3	R33	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSAN09T1G	Active High, LP and FT Mode	0.9	B09B	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585HSAN12T1G	Active High, LP and FT Mode	1.2	B12B	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585HSAN18T1G	Active High, LP and FT Mode	1.8	B18B	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585HSN09T1G	Active High, LP and FT Mode	0.9	Q09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN10T1G	Active High, LP and FT Mode	1.0	Q10	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN12T1G	Active High, LP and FT Mode	1.2	Q12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN18T1G	Active High, LP and FT Mode	1.8	Q18	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585HSN30T1G	Active High, LP and FT Mode	3.0	Q30	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSAN09T1G	Active Low, LP and FT Mode	0.9	B09A	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585LSAN12T1G	Active Low, LP and FT Mode	1.2	B12A	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585LSAN18T1G	Active Low, LP and FT Mode	1.8	B18A	HSO-6 (Pb-Free)	3000 Tape & Reel
NCP585LSN09T1G	Active Low, LP and FT Mode	0.9	P09	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSN12T1G	Active Low, LP and FT Mode	1.2	P12	SOT23-5 (Pb-Free)	3000 Tape & Reel
NCP585LSN18T1G	Active Low, LP and FT Mode	1.8	P18	SOT23-5 (Pb-Free)	3000 Tape & Reel

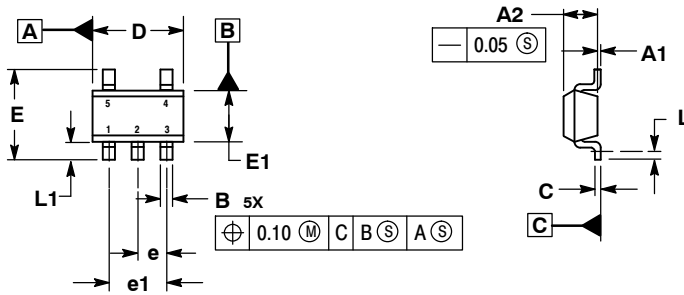
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Other voltages are available. Consult your ON Semiconductor representative.

# NCP585

## PACKAGE DIMENSIONS

SOT23-5  
SN SUFFIX  
CASE 1212-01  
ISSUE O

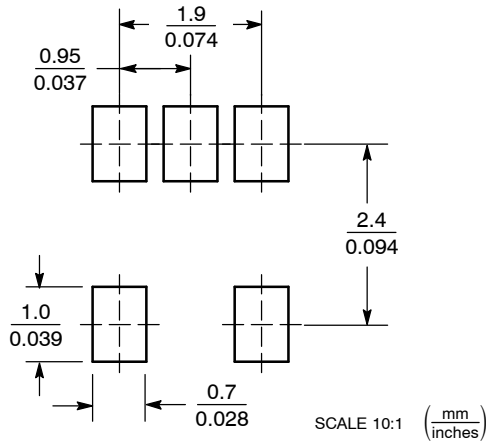


NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DATUM C IS A SEATING PLANE.

MILLIMETERS		
DIM	MIN	MAX
A1	0.00	0.10
A2	1.00	1.30
B	0.30	0.50
C	0.10	0.25
D	2.80	3.00
E	2.50	3.10
E1	1.50	1.80
e	0.95 BSC	
e1	1.90 BSC	
L	0.20	---
L1	0.45	0.75

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.